

09/889587
JC18-2001 PCT/PTO 01 AUG 2001

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Pre Grant s/18/02
#7/A 9J

In re application of: **Kasuhiko ANDO et al.**

Serial No.: **Not Yet Assigned**
(PCT/JP00/00645)

Filed: **August 1, 2001**

For: **CURABLE RESIN COMPOSITION**

PRELIMINARY AMENDMENT

Commissioner for Patents
Washington, D.C. 20231

August 1, 2001

Sir:

Prior to the calculation of the filing fees of the above application, please amend the application as follows:

IN THE SPECIFICATION:

Please replace the paragraph beginning at page 13, line 8, with the following rewritten paragraph:

A1
SUB B5
--As the (I) component, a modification product derived from the reactive silicon group-containing polyoxyalkylene polymer can also be employed. As a representative example of such modification product, there can be mentioned the polymer obtainable by polymerizing a mixture of an alkyl (meth) acrylate monomer having an alkyl group containing 1 to 8 carbon atoms as represented by the following general formula (9) and/or an alkyl (meth) acrylate monomer having an alkyl group containing 10 or more carbon atoms as represented by the following general formula (10) and/or a reactive silicon group-containing alkyl (meth) acrylate monomer of the following